



## SPECIFICATIONS

1. THIS SPECIFICATIONS APPLY TO RS6011266 POTENTIOMETERS.

2. CONTENTS OF THIS SPECIFICATIONS.

4S6028-411M  
4S0008-45M  
4S0001-200M, 4S0001-201M  
S6028P623A

3. MARKING

• MARKING ON ALL UNITS  
DATE CODE, RESIST. VALUE, TAPER, TRADE MARK, JAPAN

4. REMARKS

• NOTES

• Marking ⇒ in specifications shows standard and condition for application.

CLASS. NO. TITLE STANDARD TYPE POTENTIOMETER (SLIDE, ELECTRICAL

ELECTRICAL

- 1. Overall resistance : Overall resistance tolerances :  $\pm 20\%$  Unit : K $\Omega$

5	10	20	50	100	200	250	500	1,000
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- 2. Minimum resistance : Unit :  $\Omega$

Overall resistance (K $\Omega$ )	5, 10	20, 50	100	200,	500	1000
Across term. 1-2	30	50	100	200	300	500
Across term. 2-3	50	70	120	220	320	500

3. Taper : "A" (SAS16)

4. Rated power : 0.1 Watts.

5. Rated voltage : Rated voltage =  $\sqrt{P \cdot R}$  (V)

P : rated power (W)

R : nominal overall resistance ( $\Omega$ )

When the rated voltage exceeds the maximum operating voltage the maximum operating voltage shall be the rated voltage.

Maximum operating voltage : A.C. 150 V, D.C. 10 V

6. Dielectric test : Units shall be designed to withstand 300 volts A.C. 50 Hz R.M.S. between resistance elements and case for a period of one minute without damage or arcing.

7. Insulation resistance : Greater than 100 megohms between resistance elements and case when tested by a 250 volts D.C. insulation resistance meter.

8. Tracking error : 3 dB from -40 to 0 dB

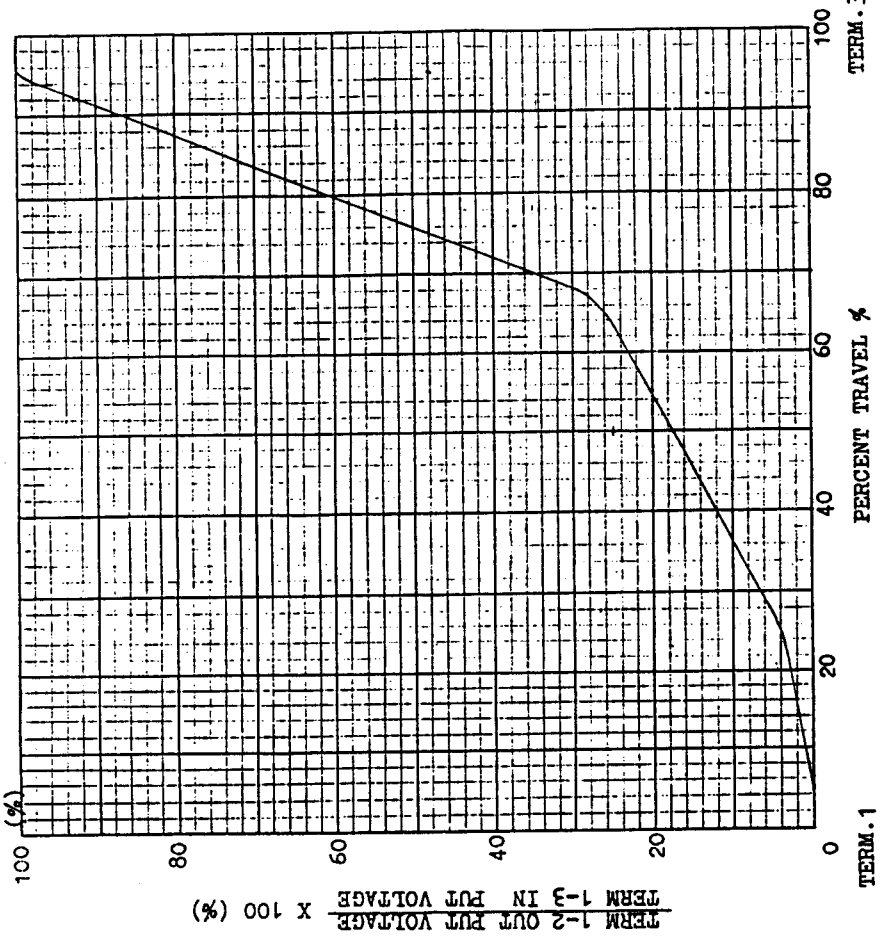
9. Sliding lifetest : 15,000 cycles

\* Lever shall be operable with speed of 20 mm per sec. without noise by static electricity.

SYMB		DATE	APPD	CHKD	DSGD	TITLE SPECIFICATIONS	
			Aug. 9/91			DOCUMENT NO. 4S6028-411M	
						ALPS ELECTRIC CO., LTD.	

USED ON	NAME
45.60 mm TRAVEL TYPE	RESISTANCE TAPER
ALPS ELECTRIC CO., LTD.	TITLE
1-7 YUKIGAYA OTSUKA-CHO	SPECIFICATIONS
OTA-KU TOKYO JAPAN	

TAPERED CURVE: "A"



NOTES: PERCENT VOLTAGE CHECK POINT 50% TRAVEL FROM TERM.1 TOLERANCE 10-25%

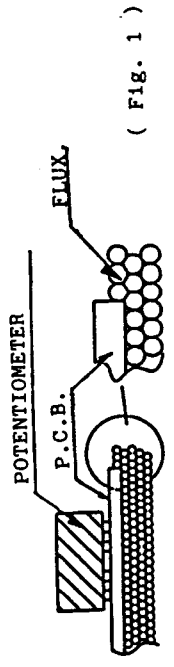
SYMB	DATE	APPD	CHKD	DSGD	APPD	CHKD	DSGD	NAME
					Aug. 28.81			RESISTANCE TAPER
								DWG. NO. SAS16





FOLLOW THE NEXT CONDITIONS FOR SOLDERING

1. Solder  
63 % Sn solder specified in JIS Z3282.
2. Board in Use  
Double-faces through-hole board or  
Single-face copper laid laminate board.  
Plate thickness (t) = 1.6 mm
3. In the Case of Dip Soldering
  - (1) State of potentiometer  
Position a lever in the vicinity of center.
  - (2) Specific Gravity of Flux  
0.83±0.01 (foaming type)
  - (3) Height of Flux face  
A level of the upper face of flux for reaching the position at a half of the plate thickness of printed board. ( Fig.1)  
Further, no flow of flux invading on the surface of printed board on the side of installing potentiometer is allowed.



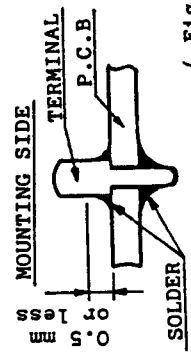
( Fig. 1 )

- (4) Preheat Condition  
100 °C MAX., within 1 minute  
( Temperature on the side of installing printed board is designated. )
- (5) Soldering Condition  
Solder temperature; 260 °C MAX.  
Soldering period ; within 5 seconds  
Time of soldering ; only one time is permitted

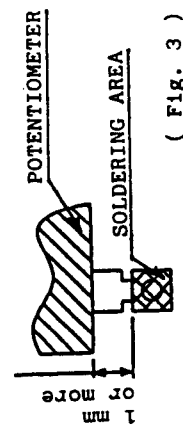
4. In the Case of Manual Soldering  
Solder temperature ; 300 °C MAX.  
Soldering period ; within 3 seconds  
Time of soldering ; only one time is permitted

5. Matters to Be Noted

- (1) Do not add any stress on terminals in the case of soldering.  
For instance, forced movement of potentiometer with terminals being heated may probably deteriorate the electric features due to generation of looseness in connection between resistant board and terminals.
- (2) Avoid use of double-faces through-hole board as much as possible. If it is necessary to use it. Do not apply through-hole plating to a hole in which a potentiometer is inserted, and install a land to which terminals are soldered only on a face opposite to the face on the side of installing potentiometer.
- (3) Use caution to soldering process so as to prevent solder from rising up to the surface of printed board on the side of installing potentiometer, because defective contact may take place in terminal connecting part due to soldering heat ( Fig. 2 )
- (4) In the case of lead wiring, solder it so that a gap of 1 mm or more may be reserved between the potentiometer body and soldering part. ( Fig. 3 )



( Fig. 2 )



( Fig. 3 )

- (5) The grade of influence of soldering exerted on the potentiometer depends upon the size of a printed board, installing position of the potentiometer, and the size of a solder bath etc. Therefore, make sure, in advance, of no abnormal state under the conditions of soldering to be carried out at present.

SYMR	DATE	APPD.	CHKD.	DSCD.
		App. 15 '91	App. 5 '91	App. 5 '91
<b>ALPS ELECTRIC CO., LTD.</b>				
				TITLE
				SLIDE POTENTIOMETER
				DOCUMENT NO.
				4S0001 -- 201M

